

FDC3535 P-Channel Power Trench[®] MOSFET -80 V, -2.1 A, 183 m Ω

Features

- Max $r_{DS(on)}$ = 183 m Ω at V_{GS} = -10 V, I_D = -2.1 A
- Max $r_{DS(on)}$ = 233 m Ω at V_{GS} = -4.5 V, I_D = -1.9 A
- High performance trench technology for extremely low r_{DS(on)}
 High power and current handling capability in a widely used surface mount package
- Fast switching speed
- 100% UIL Tested
- RoHS Compliant

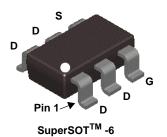


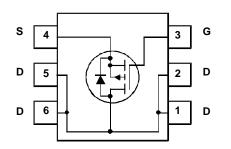
General Description

This P-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process that has been optimized for $r_{DS(on)}$, switching performance and ruggedness.

Applications

- Load Switch
- Synchronous Rectifier





MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter		Ratings	Units V	
V _{DS}	Drain to Source Voltage	-80			
V _{GS}	Gate to Source Voltage		±20	V	
	Drain Current -Continuous	(Note 1a)	-2.1	•	
D	-Pulsed		-10	Α	
E _{AS}	Single Pulse Avalanche Energy	(Note 3)	37	mJ	
Ĺ	Power Dissipation	(Note 1a)	1.6	W	
PD	Power Dissipation	(Note 1b)	0.7	vv	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	30	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 1	a) 78	C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
.535	FDC3535	SSOT-6	7 "	8 mm	3000 units

June 2010

Max	Units
	V
	mV/°C
-1	μA
±100	nA
-3	V
	mV/°C
183	
233	mΩ
307	1
	S
880	nF

nC

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033		D -				
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I_D = -250 µA, referenced to 25 °C		-64		mV/°
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -64 V, V _{GS} = 0 V		-	-1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Char	acteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \ \mu A$	-1	-1.6	-3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = -250 μ A, referenced to 25 °C		5		mV/°0
		V _{GS} = -10 V, I _D = -2.1 A		147	183	
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = -4.5 V, I _D = -1.9 A		176	233	mΩ
		V _{GS} = -10 V, I _D = -2.1 A, T _J = 125 °C		246	307	
9 _{FS}	Forward Transconductance	V _{DD} = -10 V, I _D = -2.1 A		6.3		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance	V 40.V V 0.V		659	880	pF
C _{oss}	Output Capacitance	$V_{DS} = -40 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ = 1 MHz		49	65	pF
C _{rss}	Reverse Transfer Capacitance			24	40	pF
R _g	Gate Resistance			5.7		Ω
Switchin	g Characteristics					
t _{d(on)}	Turn-On Delay Time			6.5	13	ns
t _r	Rise Time	V _{DD} = -40 V, I _D = -2.1 A,		3.1	10	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = -10 V, R_{GEN} = 6 Ω		23	38	ns
t _f	Fall Time			2.9	10	ns
0	Total Gate Charge	$V_{GS} = 0 V \text{ to } -10 V$		14	20	nC
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0 \text{ V to } -4.5 \text{ V} \text{ V}_{DD} = -40 \text{ V}$		6.8	10	nC
Q _{gs}	Total Gate Charge	I _D = -2.1 A		1.6		nC

Test Conditions

 $I_D = -250 \ \mu A, \ V_{GS} = 0 \ V$

Min

-80

Тур

Drain-Source Diode Characteristics

Gate to Drain "Miller" Charge

Electrical Characteristics T_J = 25 °C unless otherwise noted

Parameter

Drain to Source Breakdown Voltage

V_{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = -2.1 A$	(Note 2)	-0.81	-1.3	V
t _{rr}	Reverse Recovery Time	I _E = -2.1 A, di/dt = 100 A/		25	40	ns
Q _{rr}	Reverse Recovery Charge	F = -2.1 A, u/ut = 100 A/	μο	23	38	nC

NOTES:

 Q_{gd}

Symbol

BV_{DSS}

Off Characteristics

1. R_{eUA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{eUC} is guaranteed by design while R_{eCA} is determined by the user's board design.



a. 78 °C/W when mounted on a 1 in² pad of 2 oz copper



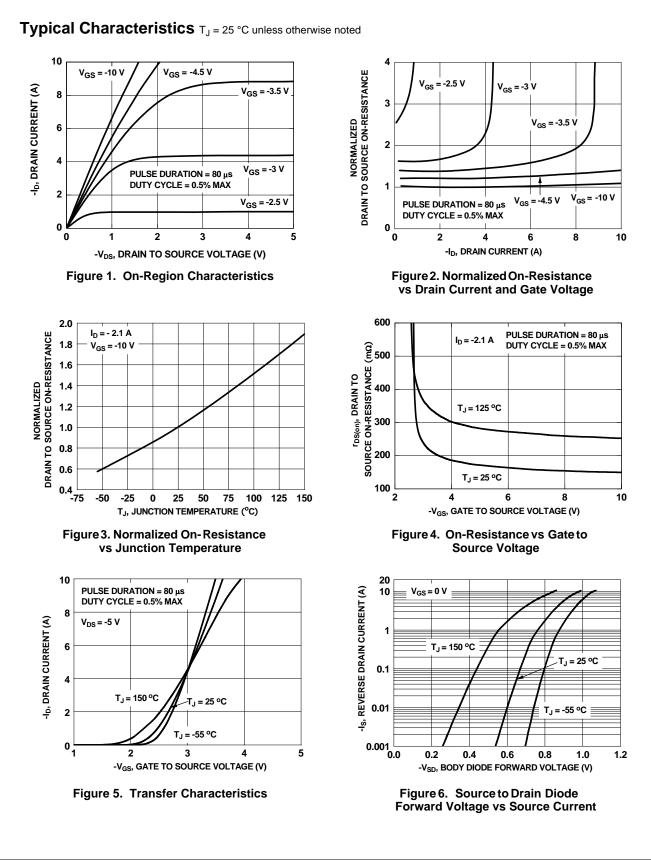
b.175 °C/W when mounted on a minimum pad of 2 oz copper

2.7

2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0 %.

3. Starting T_J = 25 °C, L = 3 mH, I_{AS} = -5 A, V_{DD} = -80 V, V_{GS} = -10 V.

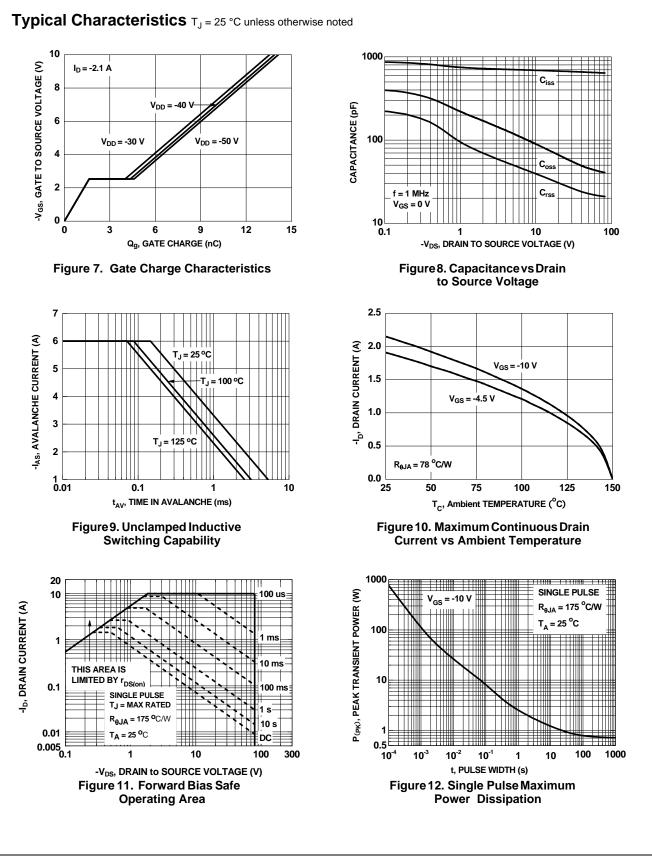
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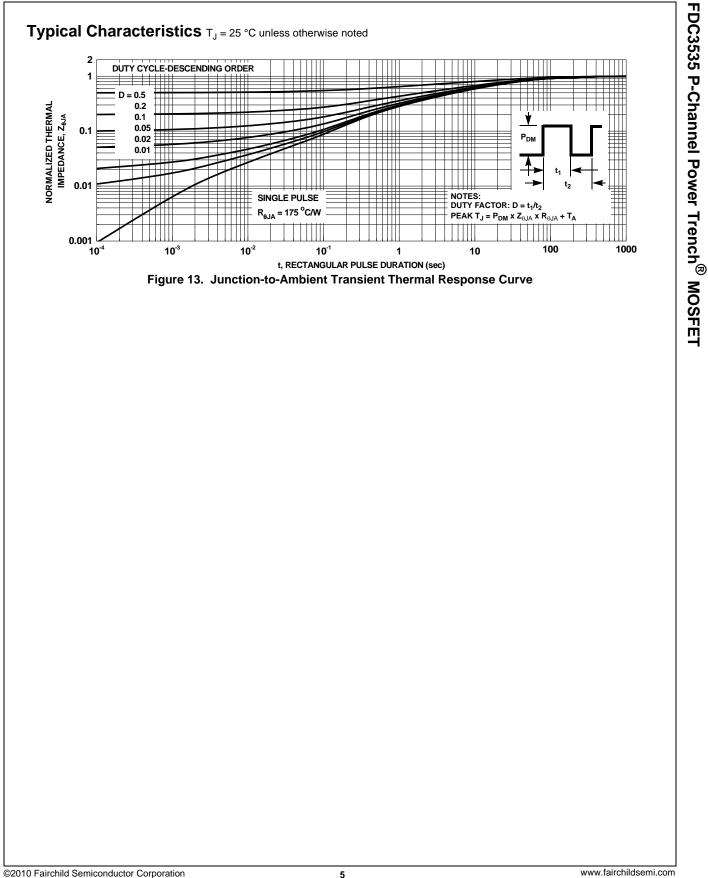
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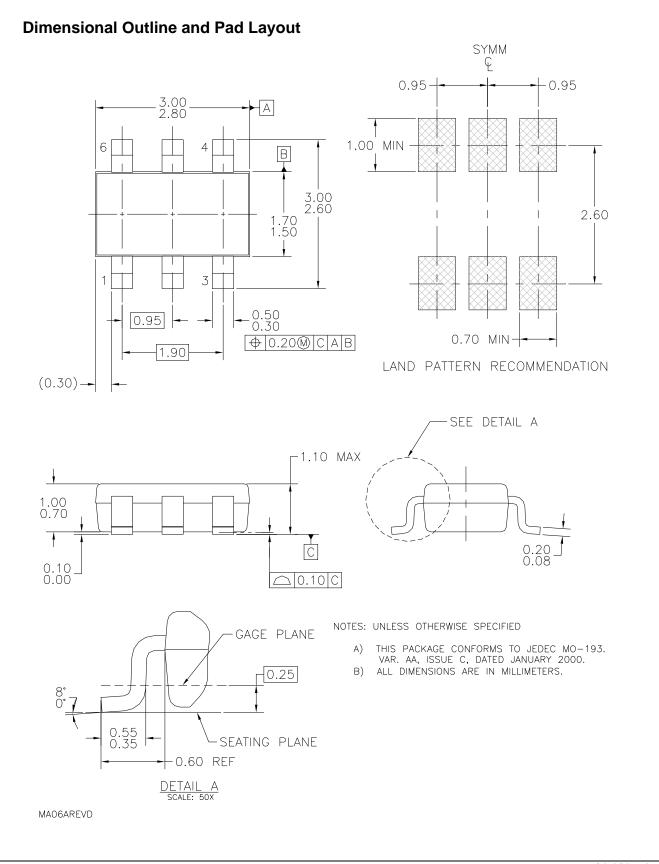
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